

Ultra-Low Capacitance TVS Protection

DESCRIPTIONS

CMTLDF02CR35AFE is low-capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for high-speed data interfaces. With typical capacitance of 0.35pF only, CMTLDF02CR35AFE is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2 (ESD), Level 4 (±15kV air, ±8kV contact discharge), IEC 61000-4-4 (electrical fast transient - EFT) (40A,5/50 ns), very fast charged device model (CDM) ESD and cable discharge event (CDE), etc.

CMTLDF02CR35AFE uses ultra-small uDFN-2L package. Each CMTLDF02CR35AFE device can protect one high-speed data line. It offers system designers flexibility to protect single data line where space is a premium concern. The combined features of low capacitance, ultra-small size and high ESD robustness make CMTLDF02CR35AFE ideal for high-speed data port and high-frequency line (e.g., USB 2.0 & antenna line) applications, such as cellular phones and HD visual devices.

♦ FEATURES

1. Transient protection for high-speed data lines IEC 61000-4-2 (ESD) ±15kV (Air)

±8kV (Contact)

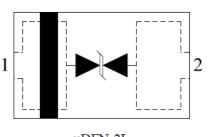
IEC 61000-4-4 (EFT) 40A (5/50 ns) Cable Discharge Event (CDE)

- 2. Package optimized for high-speed lines
- 3. Ultra-small package (1.0mm×0.6mm×0.4mm)
- 4. Protects one data, control or power line
- 5 Low capacitance: 0.35pF (Typical)
- 6. Low leakage current: 10nA @ VRWM (Typical)
- 7. Low clamping voltage

♦ Circuit Diagram



♦ Pin Configuration



uDFN-2L (Top View)

Applications

- 1、10M / 100M / 1G Ethernet
- 2 PCI Express
- 3、PC / Note book
- 4. Cellular Phones
- 5、MDDI Ports
- 6. USB2.0 Power and Data Line Protection
- 7. Display Ports
- 8、HDMI/DVI ports

◆ Mechanical Characteristics

- 1, uDFN-2L package
- 2. Flammability Rating: UL 94V-0
- 3. Marking: Part number (S)
- 4. Packaging: Tape and Reel

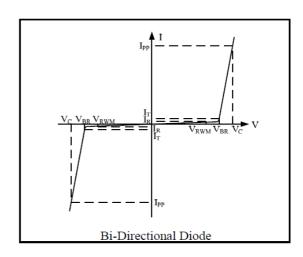


◆ Absolute Maximum Rating

Symbol	Parameter	Value	Units
V _{ESD}	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	±17 ±12	kV
T _{OPT}	Operating Temperature	-55/+125	$^{\circ}$
T _{STG}	Storage Temperature	-55/+150	$^{\circ}$

♦ Electrical Characteristics (T = 25°C)

Symbol	Parameter			
Vrwm	Nominal Reverse Working Voltage			
lR	Reverse Leakage Current @ VRWM			
V _{BR}	Reverse Breakdown Voltage @ IT			
lτ	Test Current for Reverse Breakdown			
V c	Clamping Voltage @ IPP			
I PP	Peak Pulse Current			
CESD	Parasitic Capacitance			
V R	Reverse Voltage			
f	Small Signal Frequency			



Symbol	Test Condition	Minimum	Typical	Maximum	Units
V_{RWM}				5.0	V
I _R	V _{RWM} = 5V, T = 25 °C Between I/O and I/O		0.01	1.0	μΑ
V_{BR}	I _T = 1mA Between I/O and I/O	6.0	8.8	11	V
V _C	I _{PP} = 1A, tp = 8/20μs Between I/O and I/O			12	V
V _C	I _{PP} = 2A, tp = 8/20μs Between I/O and I/O			14	V
C_{ESD}	V _R = 0V, f = 1MHz Between I/O and I/O		0.35	0.50	pF

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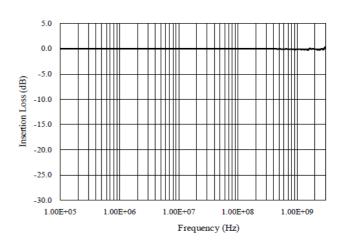


◆ TYPICAL ELECTRICAL CHARACTERISTICS CURVE

Voltage Sweeping of I/O to I/O

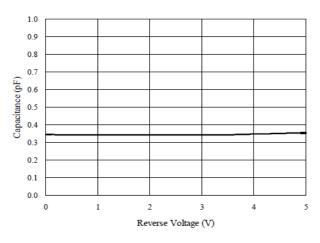
0.12 0.00 0.04 0.04 0.04 0.04 0.00 -0.02 -0.04 -0.06 -0.08 -0.10 -0.12 -10 -8 -6 -4 -2 0 2 4 6 8 10 Voltage (V)

Insertion Loss S21 of I/O to I/O

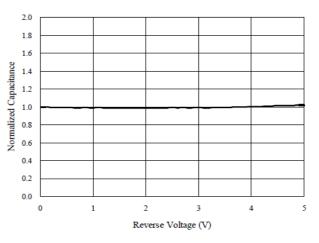


Capacitance vs. Voltage of I/O to I/O (f = 1MHz)

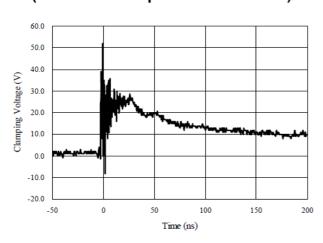
Capacitance vs. Reverse Voltage



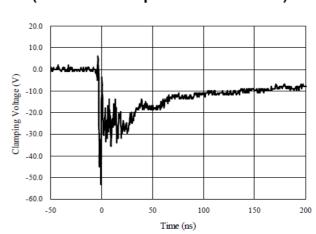
Normalized Capacitance vs. Reverse Voltage



ESD Clamping of I/O to I/O (+8kV Contact per IEC 61000-4-2)



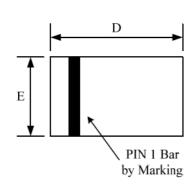
ESD Clamping of I/O to I/O (-8kV Contact per IEC 61000-4-2)

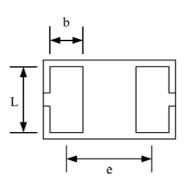


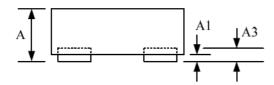


◆ PACKAGE OUTLINE

- 1、uDFN-2L package
- 2、2 leads, very small package
- 3、Thermally-Enhanced







Package Dimensions (Controlling dimensions are in millimeters)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Minimum	Maximum	Minimum	Maximum
A	0.400	0.550	0.016	0.022
A1	0.000	0.050	0.000	0.002
A3	0.125 REF		0.005 REF	
D	0.950	1.050	0.037	0.041
Е	0.550	0.650	0.022	0.026
b	0.200	0.300	0.008	0.012
e	0.650 BSC		0.026 BSC	
L	0.450	0.550	0.018	0.022

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